

FD2H003BY FD2H003Ba FD2H003BH

Low-Power Hall Switch



General Description

FD2H003B*-G1 is a low-power integrated Hall switch designed to sense the applied magnetic flux density and give a digital output, which indicates the present condition of the magnitude sensed. One example of the applications is the on/off switch in cellular flip-phones.

The micro power design is especially suitable for battery-operated systems such as cellular phones or laptop computers, in which power consumption is one major concern. The typical power consumption of FD2H003B*-G1 is below 10µW at 2.7V.

The magnetic switching points are precise and insensitive to process and temperature variations.

For FD2H003B*-G1, the output will be at the "high" level when no magnetic field is applied. When the applied magnetic flux density is stronger than the switching threshold, the output would be at the "low" level.

Features

- > Micro power consumption
- > 1.8V to 5.5V battery operation
- Chopper Amplifier based design: Insensitive to noise and offset caused by process variations, operating temperatures and mechanical stress Digital output
- CMOS process
- > CMOS output stage : no external pull-up resistor needed



Pin Descriptions

FD2H003BYR-G1



Name	I/O	Description
VDD	Р	Positive supply
Q	0	Open Drain output
VSS	G	Ground

Legend: I=input, O=output, I/O=input/output, P=power supply, G=ground

FD2H003BaR-G1



FD2H003BH-G1





Marking Information



Halogen Free: Halogen free product indicator Lot Number: Wafer lot number's last two digits

For Example \rightarrow Lot : 123466 \rightarrow XXx-66L

Internal ID: Internal Identification Code

Per-Half Month: Production period indicator in half month time unit

- For Example : A \rightarrow First Half Month of January
 - $\mathsf{B}\ \to$ Second Half Month of January
 - $\mathsf{C} \ \rightarrow \text{First Half Month of February}$
 - $\mathsf{D} \ \rightarrow \text{Second Half Month of February}$

Year: Production year's last digit

Part Number Code: Part number identification code for this product.

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Block Diagram



Figure.1

Functional Descriptions

Refer to the block diagram (Figure.1), FD2H003-LF is composed of the following building blocks:

• Bias Generator

The bias generator provides precise, temperature and process insensitive current sources for both the Hall plate and the chopper amplifier. These current sources in turn guarantee proper operation of the chip and precise switching thresholds under all kinds of environments specified in the specification.

• Oscillator + Timing logic

The built-in oscillator provides the clock signal, which is taken by the timing logic to determine the periods of the operating phase and the stand-by phase. Typically the operating time is about 60us and the stand-by time is 150ms. Using such a clocking scheme, the average power consumption is almost equal to that in the stand-by phase, which is under 10µW at 2.7V.

• Chopper Amplifier

To achieve a higher resolution the chopper amplifier structure is adopted in this design. Use of this structure dynamically removes both the offset and flicker noise at the same time.

Comparator with Hysteresis Control

This block determines the switching threshold of the Hall switch in different situations.

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Ordering information

Part Number	Operating Temperature	Part Number Code	Package	Description	MOQ
FD2H003BYR-G1	-20 °C to +105 °C	CE	SOT23	±25G (B)	3000ea / Reel
FD2H003BaR-G1	-20 °C to +105 °C	CE	TSOT23	±25G (B)	3000ea / Reel
FD2H003BH-G1	-20 °C to +105 °C	-	SIP3	±25G (B)	1000ea / Bag

Absolute Maximum Ratings

Parameter	Conditions	Min.	Max.	Unit
Ambient Operating Temperature	-	-40	85	°C
Storage Temperature	-	-40	150	°C
DC Supply Voltage	-	1.8	5.5	V
Supply Current	-	-1	2.5	mA
Programming Pin Voltage (only available for FD2H003B*-G1)	With respect to VSS	-0.3	5.5	V
Magnetic Flux Density	-		unlimited	G
Lead Temperature	10sec	-	260	°C

IR Re-flow Soldering Curve



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Operating Conditions

Parameter	Conditions	Min.	Тур.	Max.	Unit
Supply Voltage	-	1.8	2.7	5.5	V
Output Voltage	-	-0.3	2.7	5.5	V
Ambient Temperature	-	-40	25	85	°C

Electrical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Average Supply Current	-	-	3 ¹	20	μA
Average Supply Current (operating phase)	-	-	1.1 ¹	-	mA
Average Supply Current (stand-by phase)	-	-	2.5 ¹	-	μA
Output High Voltage(VOH)	lo=-0.5mA	VDD-0.4V	-		V
Output Low Voltage(VOL)	lo=+0.5mA	-	-	0.4V	V
Output Leakage Current	-	-	0.01	-	μA
Operating time	-	-	60	-	μs
Standby time	-	-	150	-	ms
Duty cycle	-	-	0.04	-	%

1. operating voltage 2.7V

Magnetic Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Operate Points (B _{OP})	-	15	25	35	G
Hysteresis	-	5	10	15	G



Magnetic Flux



Figure 3. FD2H003B*-G1



Typical Characteristics







Figure.5 Magnetic Switch Points Versus Supply Voltage (Ta=25C degree)

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Figure.6 Average Current Versus Supply Voltage (Ta=25C degree)



Figure.7 Average Current Versus Ambient Temperature (VDD=2.7V)

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Application Circuit Reference



NOTE:

1. R1 is for power supply filtering function, and must be placed as close to IC1 as possible.

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Package Outline

SOT23(FD2H003BYR-G1)



Unit: mm

Symbols	Min. (mm)	Max. (mm)			
A	-	-	1.45		
A1	-	-	0.15		
A2	0.90	1.15	1.30		
b	0.30	-	0.50		
с	0.08	-	0.22		
D		2.90 BSC.			
E		2.80 BSC			
E1		1.60 BSC			
е		0.95 BSC			
e1		1.90 BSC			
L	0.30	0.45	0.60		
L1		0.60 REF.			
L2	0.25 BSC				
R	0.10				
R1	0.10 - 0.25				
θ°	0° 4° 8°				
θ1°	5°	10°	15°		



TSOT-23L(FD2H003BaR-G1)



Unit: mm

	Dime	ension In Millime	eters		
Symbols	Min	Nom	Max		
А	0.750	-	0.800		
A1	0.025	-	0.050		
A2	0.700	0.750	0.775		
b	0.350	-	0.500		
с	0.100	-	0.200		
D	2.800	2.900	3.000		
Е	2.600	2.800	3.000		
E1	1.500	1.500 1.600			
е		0.950 BSC			
e1		1.900 BSC			
L	0.370	0.370 0.450			
L1		0.600 REF			
L2	0.250 BSC				
R	0.100	-	-		
R1	0100	0100 -			
Θ	0° 4° 8°				
Θ1	4°	12°			

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SIP-3L (FD2H003BH-G1)



Unit: mm

Symbols	Min. (mm)	Max. (mm)				
А	1.245	-	1.753			
A1		0.75REF				
b	0.33	0.33 - 0.56				
b1	0.54 REF					
D	3.85 - 4.2					
E	2.87 - 3.124					
L	13.5	-	15.6			
е	1.27 REF					

Note:

- 1. Dimension "D" does not include molding flash, protrusions or gate burrs.
- 2. Dimension "E" does not include interlead flash, protrusions.

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